1.6x0.6mm RIGHT ANGLE SMD CHIP LED LAMP

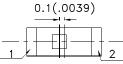
The Hyper Red device is based on light emitting diode chip

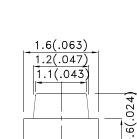
Part Number: KPA-1606SECK-J3 Hyper Red

Features

- 1.6mmx0.6mm right angle SMT LED,1.2mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package :2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

Package Dimensions





0.25(.01)



1 -

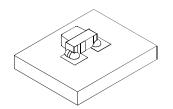
.2(.047)

6(.024)

-⊳ 2

Description

made from AlGaInP.



Notes:

1. All dimensions are in millimeters (inches).

2. Tolerance is ±0.1(0.004") unless otherwise noted.

POLARITY MARK

The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
The device has a single mounting surface. The device must be mounted according to the specifications.

0.25(.01)

REV NO: V.1A CHECKED: Allen Liu DATE: MAR/25/2013 DRAWN: Y.Liu



Selection Guide

Selection Guide					
Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KPA-1606SECK-J3	Liver Ded (AlColeD)	Water Clear	700	1100	110°
	Hyper Red (AlGaInP)		*200	*380	

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity/ luminous Flux: +/-15%. *Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	640		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red	625		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	20		nm	IF=20mA
С	Capacitance	Hyper Red	27		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	2.2	2.8	V	IF=20mA
lr	Reverse Current	Hyper Red		10	uA	VR=5V

Notes:

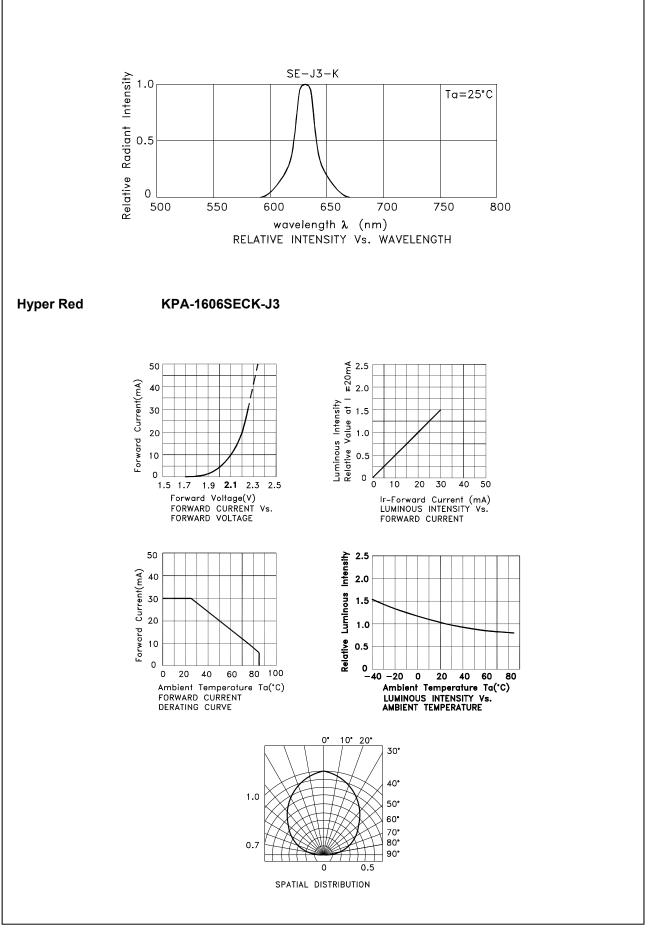
Wavelength: +/-1nm.
Forward Voltage: +/-0.1V.
Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Units	
Power dissipation	84	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note:

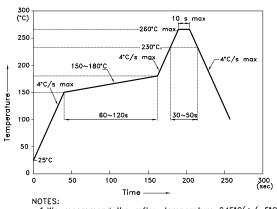
1. 1/10 Duty Cycle, 0.1ms Pulse Width.



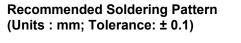
KPA-1606SECK-J3

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



NOTES: 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature. 3.Number of reflow process shall be 2 times or less.



Reel Dimension

